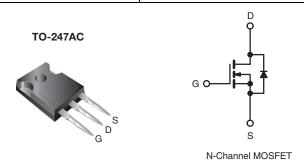


## Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	500			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.60		
Q <sub>g</sub> (Max.) (nC)	84			
Q <sub>gs</sub> (nC)	8.4			
Q <sub>gd</sub> (nC)	50			
Configuration	Single			



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





#### **DESCRIPTION**

Third Generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

TO-247AC package is preferred commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP448PbF
Lead (FD)-lifee	SiHFP448-E3
SnPb	IRFP448
SIFD	SiHFP448

ABSOLUTE MAXIMUM RATINGS ( $T_{C}$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	500	V	
Gate-Source Voltage			$V_{GS}$	± 20		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	1	11	А	
Continuous Drain Current		T <sub>C</sub> = 100 °C	ID	6.6		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	44		
Linear Derating Factor				1.4	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	550	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	11	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	18	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	P <sub>D</sub>	180	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	1	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 8.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 11 A (see fig. 12). c.  $I_{SD}$  ≤ 11 A, dI/dt ≤ 120 A/ $\mu$ s,  $V_{DD}$  ≤  $V_{DS}$ ,  $T_J$  ≤ 150 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.70		

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT		
Static					•	•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	500	-	-	V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.60	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	V <sub>GS</sub> = ± 20 V		-	± 100	nA	
Zere Oete Velhere Duein Ormant	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V		-	-	25	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 400 \text{ V}, \text{ V}$	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	250		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6.6 A <sup>b</sup>	-	-	0.60	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 6.6 A <sup>b</sup>		6.7	-	-	S	
Dynamic								
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0  MHz,  see fig. 5		-	1900	-	pF	
Output Capacitance	C <sub>oss</sub>			-	490	-		
Reverse Transfer Capacitance	$C_{rss}$			-	220	-		
Total Gate Charge	$Q_g$			-	-	84		
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$ $I_D = 9.6 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	8.4	nC		
Gate-Drain Charge	$Q_gd$		See fig. 6 and 16		-		50	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 250 \text{ V, } I_D = 9.6 \text{ A },$ $R_G = 7.8 \ \Omega, \ R_D = 27 \ \Omega, \text{ see fig. } 10^b$		-	18	-	- ns	
Rise Time	t <sub>r</sub>			-	40	-		
Turn-Off Delay Time	$t_{d(off)}$			-	62	-		
Fall Time	t <sub>f</sub>			-	32	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	-11	
Internal Source Inductance	L <sub>S</sub>			-	13	-	- nH	
Drain-Source Body Diode Characteristic	s				•	•		
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	- A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	44		
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 11  \text{A},  V_{GS} = 0  V^b$		-	-	1.7	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 9.6 A, dI/dt = 100 A/μs <sup>b</sup>		-	480	1100	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	5.2	12	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-			rn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )			

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.





## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

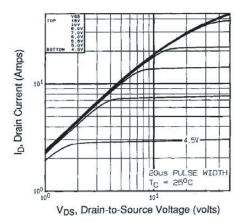


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

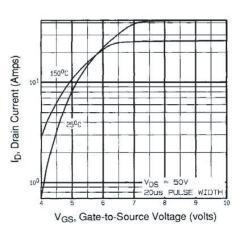


Fig. 3 - Typical Transfer Characteristics

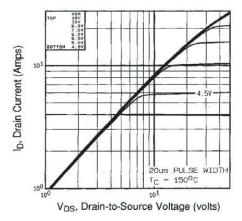


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

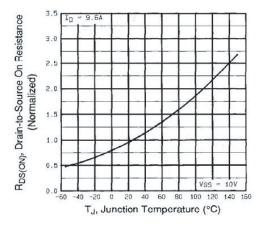


Fig. 4 - Normalized On-Resistance vs. Temperature



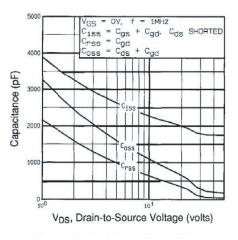


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

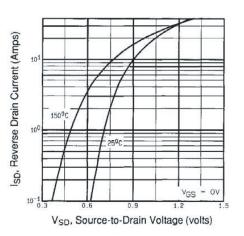


Fig. 7 - Typical Source-Drain Diode Forward Voltage

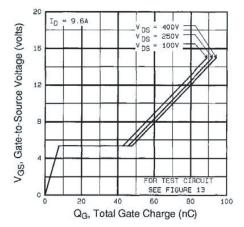


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

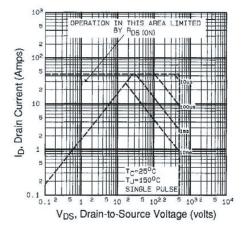


Fig. 8 - Maximum Safe Operating Area



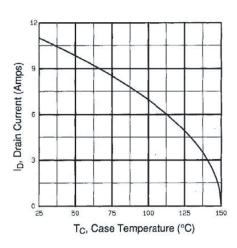


Fig. 9 - Maximum Drain Current vs. Case Temperature

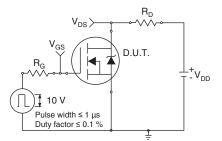


Fig. 10a - Switching Time Test Circuit

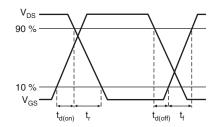


Fig. 10b - Switching Time Waveforms

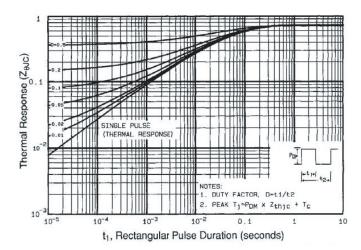


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



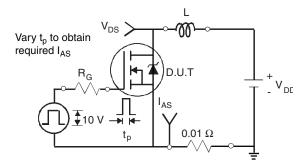


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

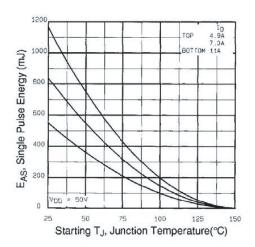


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

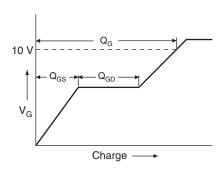


Fig. 13a - Basic Gate Charge Waveform

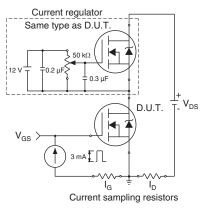
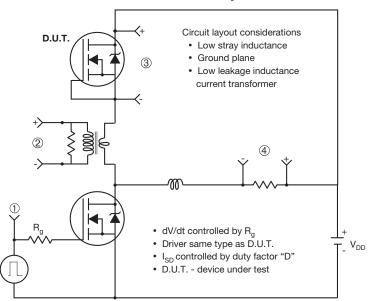


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



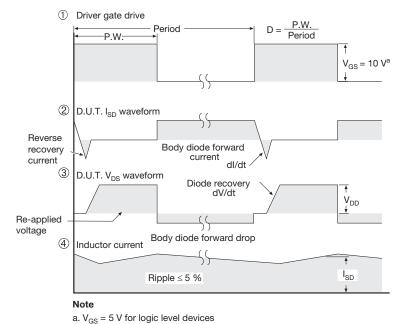


Fig.14 - For N-Channel

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